DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

DOCKET NO. **CS2001-001**

As a below named Inventor, I hereby declare that:

the specification of which (check one)

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **A Method To Improve Adhesion Of Dielectric Films In Damascene Interconnects**

X is attached hereto.			
was filed on			
Application Serial No.			
and was amended on			
I hereby state that I have reviewed and amended by any amendment referred to	understand the contents of the a	bove Identified specification including the claims, a	ıs
I acknowledge the duty to disclose infor 37, Code of Federal Regulations, §1.56	mation which is material to the (a).	examination of this application in accordance with	Title
inventor's certificate listed below and he filing date before that of the application	ave also identified below any for	de §119 of any foreign application(s) for patent or reign application for patent or inventor's certificate	havin
Prior Foreign Application(s)		Priority Claimed:	
oraci			
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	
national of PC1 international limits date	of this application.	ny United States application(s) listed below and, inclosed in the prior United States application in the market acknowledge the duty to disclose material information between the filing date of the prior application and the pri	ianner ition a and th
(Application Serial No.)	(Filing Date) (Status)) (patented, pending, abandoned)	
haliations haliawad to be terror and trethe	er that these statements were ma or imprisonment, or both under	are true and that all statements made on information and with the knowledge that willful false statements or Section 1001 of Title 18 of the United States Codlication or any patent issued thereon.	ann
POWER OF ATTORNEY: As a named application and transact all business in t	l inventor, I hereby appoint the the Patent and Trademark Office	following attorney(s) and/or agent(s) to prosecute to connected therewith. (list name & registration no.	this)
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